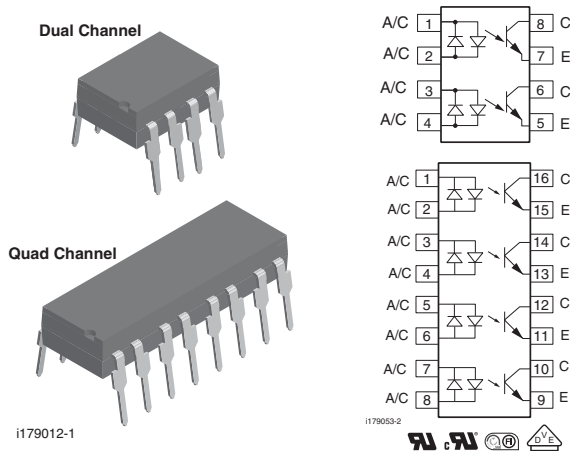


## Optocoupler, Phototransistor Output, AC Input (Dual, Quad Channel)



### DESCRIPTION

The ILD620, ILQ620, ILD620GB, and ILQ620GB are multi-channel input phototransistor optocouplers that use inverse parallel GaAs IRLED emitter and high gain NPN silicon phototransistors per channel. These devices are constructed using over/under leadframe optical coupling and double molded insulation resulting in a withstand test voltage of 5300 V<sub>RMS</sub>.

The LED parameters and the linear CTR characteristics make these devices well suited for AC voltage detection. The ILD620GB and ILQ620GB with its low I<sub>F</sub> guaranteed CTR<sub>CEsat</sub> minimizes power dissipation of the A<sub>C</sub> voltage detection network that is placed in series with the LEDs. Eliminating the phototransistor base connection provides added electrical noise immunity from the transients found in many industrial control environments.

### FEATURES

- Identical channel to channel footprint
- ILD620 crosses to TLP620-2
- ILQ620 crosses to TLP620-4
- High collector emitter voltage, BV<sub>CEO</sub> = 70 V
- Dual and quad packages feature:
  - Reduced board space
  - Lower pin and parts count
  - Better channel to channel CTR match
  - Improved common mode rejection
- Isolation test voltage 5300 V<sub>RMS</sub>
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

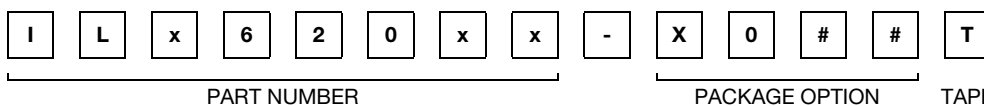


RoHS  
COMPLIANT

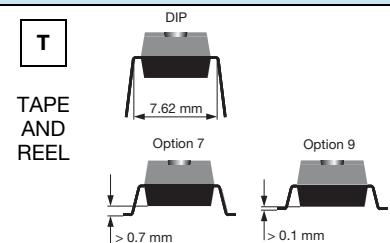
### AGENCY APPROVALS

- UL1577, file no. E52744 system code H, double protection
- cUL tested to CSA 22.2 bulletin 5A
- DIN EN 60747-5-2 (VDE 0884)/DIN EN 60747-5-5 pending available with option 1
- FIMKO

### ORDERING INFORMATION



x = D (Dual) or Q (Quad)



AGENCY CERTIFIED/PACKAGE	DUAL CHANNEL		QUAD CHANNEL	
	CTR (%)			
UL, cUL, FIMKO	50 to 600	100 to 600	50 to 600	100 to 600
DIP-8	ILD620	ILD620GB	-	-
SMD-8, option 7	ILD620-X007T <sup>(1)</sup>	-	-	-
SMD-8, option 9	ILD620-X009T <sup>(1)</sup>	ILD620GB-X009T <sup>(1)</sup>	-	-
DIP-16	-	-	ILQ620	ILQ620GB
SMD-16, option 7	-	-	ILQ620-X007	-
SMD-16, option 9	-	-	ILQ620-X009T <sup>(1)</sup>	ILQ620GB-X009T <sup>(1)</sup>
VDE, UL, cUL, FIMKO	50 to 600	100 to 600	50 to 600	100 to 600
DIP-16	-	-	ILQ620-X001	-
SMD-16, option 9	-	-	ILQ620-X019T <sup>(1)</sup>	-

#### Notes

- Additional options may be possible, please contact sales office.
- (1) Also available in tubes, do not put T on the end.



ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
<b>INPUT</b>					
Forward current			I <sub>F</sub>	± 60	mA
Surge current			I <sub>FSM</sub>	± 1.5	A
Power dissipation			P <sub>diss</sub>	100	mW
Derate linearly from 25 °C				1.3	mW/°C
<b>OUTPUT</b>					
Collector emitter breakdown voltage			BV <sub>CEO</sub>	70	V
Collector current			I <sub>C</sub>	50	mA
	t < 1 s		I <sub>C</sub>	100	mA
Power dissipation			P <sub>diss</sub>	150	mW
Derate from 25 °C				2	mW/°C
<b>COUPLER</b>					
Isolation test voltage	t = 1 s		V <sub>ISO</sub>	5300	V <sub>RMS</sub>
Isolation voltage			V <sub>IORM</sub>	890	V <sub>P</sub>
Total power dissipation			P <sub>tot</sub>	250	mW
Package dissipation		ILD620		400	mW
		ILD620GB		400	mW
Derate from 25 °C				5.33	mW/°C
Package dissipation		ILQ620		500	mW
		ILQ620GB		500	mW
Derate from 25 °C				6.67	mW/°C
Creepage distance				≥ 7	mm
Clearance distance				≥ 7	mm
Isolation resistance	V <sub>IO</sub> = 500 V, T <sub>amb</sub> = 25 °C		R <sub>IO</sub>	≥ 10 <sup>12</sup>	Ω
	V <sub>IO</sub> = 500 V, T <sub>amb</sub> = 100 °C		R <sub>IO</sub>	≥ 10 <sup>11</sup>	Ω
Storage temperature			T <sub>stg</sub>	- 55 to + 150	°C
Operating temperature			T <sub>amb</sub>	- 55 to + 100	°C
Junction temperature			T <sub>J</sub>	100	°C
Soldering temperature <sup>(1)</sup>	2 mm from case bottom		T <sub>sld</sub>	260	°C

**Notes**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.
- <sup>(1)</sup> Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

ELECTRICAL CHARACTERISTICS (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>INPUT</b>							
Forward voltage	I <sub>F</sub> = ± 10 mA		V <sub>F</sub>	1	1.15	1.3	V
Forward current	V <sub>R</sub> = ± 0.7 V		I <sub>F</sub>		2.5	20	μA
Capacitance	V <sub>F</sub> = 0 V, f = 1 MHz		C <sub>O</sub>		25		pF
Thermal resistance, junction to lead			R <sub>thJL</sub>		750		K/W
<b>OUTPUT</b>							
Collector emitter capacitance	V <sub>CE</sub> = 5 V, f = 1 MHz		C <sub>CE</sub>		6.8		pF
Collector emitter leakage current	V <sub>CE</sub> = 24 V		I <sub>CEO</sub>		10	100	nA
	T <sub>A</sub> = 85 °C, V <sub>CE</sub> = 24 V		I <sub>CEO</sub>		2	50	μA
Thermal resistance, junction to lead			R <sub>thJL</sub>		500		K/W



ELECTRICAL CHARACTERISTICS ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>COUPLER</b>							
Off-state collector current	$V_F = \pm 0.7\text{ V}$ , $V_{CE} = 24\text{ V}$		$I_{CEoff}$		1	10	$\mu\text{A}$
Collector emitter saturation voltage	$I_F = \pm 8\text{ mA}$ , $I_{CE} = 2.4\text{ mA}$	ILD620	$V_{CEsat}$			0.4	V
		ILQ620	$V_{CEsat}$			0.4	V
	$I_F = \pm 1\text{ mA}$ , $I_{CE} = 0.2\text{ mA}$	ILD620GB	$V_{CEsat}$			0.4	V
		ILQ620GB	$V_{CEsat}$			0.4	V

**Note**

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Channel/channel CTR match	$I_F = \pm 5\text{ mA}$ , $V_{CE} = 5\text{ V}$		CTR <sub>X</sub> /CTR <sub>Y</sub>	1 to 1		3 to 1	
CTR symmetry	$I_{CE} (I_F = -5\text{ mA})/I_{CE} (I_F = +5\text{ mA})$		$I_{CE(RATIO)}$	0.5		2	
Current transfer ratio (collector emitter saturated)	$I_F = \pm 1\text{ mA}$ , $V_{CE} = 0.4\text{ V}$	ILD620	CTR <sub>CEsat</sub>		60		%
		ILQ620	CTR <sub>CEsat</sub>		60		%
Current transfer ratio (collector emitter)	$I_F = \pm 5\text{ mA}$ , $V_{CE} = 5\text{ V}$	ILD620	CTR <sub>CE</sub>	50	80	600	%
		ILQ620	CTR <sub>CE</sub>	50	80	600	%
Current transfer ratio (collector emitter saturated)	$I_F = \pm 1\text{ mA}$ , $V_{CE} = 0.4\text{ V}$	ILD620GB	CTR <sub>CEsat</sub>	30			%
		ILQ620GB	CTR <sub>CEsat</sub>	30			%
Current transfer ratio (collector emitter)	$I_F = \pm 5\text{ mA}$ , $V_{CE} = 5\text{ V}$	ILD620GB	CTR <sub>CEsat</sub>	100	200	600	%
		ILQ620GB	CTR <sub>CEsat</sub>	100	200	600	%

SAFETY AND INSULATION RATED PARAMETERS							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Partial discharge test voltage - routine test	100 %, $t_{test} = 1\text{ s}$	$V_{pd}$	1.669			kV	
Partial discharge test voltage - lot test (sample test)	$t_{Tr} = 60\text{ s}$ , $t_{test} = 10\text{ s}$ , (see figure 2)	$V_{IOTM}$	10			kV	
		$V_{pd}$	1.424			kV	
Insulation resistance	$V_{IO} = 500\text{ V}$	$R_{IO}$	$10^{12}$			$\Omega$	
	$V_{IO} = 500\text{ V}$ , $T_{amb} = 100\text{ }^{\circ}\text{C}$	$R_{IO}$	$10^{11}$			$\Omega$	
	$V_{IO} = 500\text{ V}$ , $T_{amb} = 150\text{ }^{\circ}\text{C}$ (construction test only)	$R_{IO}$	$10^9$			$\Omega$	
Forward current		$I_{si}$			275	mA	
Power dissipation		$P_{SO}$			400	mW	
Rated impulse voltage		$V_{IOTM}$			10	kV	
Safety temperature		$T_{si}$			175	$^{\circ}\text{C}$	

**Note**

- According to DIN EN 60747-5-2 (VDE 0884) (see figure 2). This optocoupler is suitable for safe electrical isolation only within the safety ratings. Compliance with the safety ratings shall be ensured by means of suitable protective circuits.

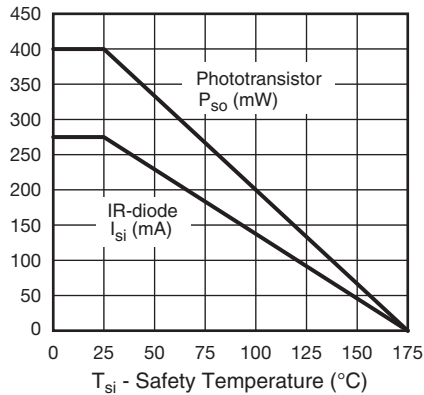


Fig. 1 - Derating Diagram

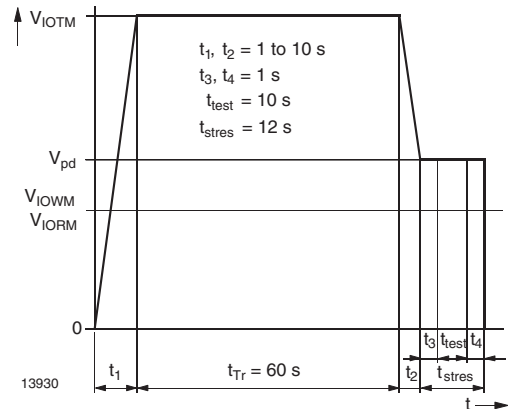


Fig. 2 - Test Pulse Diagram for Sample Test According to DIN EN 60747-5-2 (VDE 0884); IEC 60747-5-5

<b>SWITCHING CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>NON-SATURATED</b>						
On time	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 75\text{ }\Omega$ , 50 % of $V_{PP}$	$t_{on}$		3		$\mu\text{s}$
Rise time	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 75\text{ }\Omega$ , 50 % of $V_{PP}$	$t_r$		20		$\mu\text{s}$
Off time	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 75\text{ }\Omega$ , 50 % of $V_{PP}$	$t_{off}$		2.3		$\mu\text{s}$
Fall time	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 75\text{ }\Omega$ , 50 % of $V_{PP}$	$t_f$		2		$\mu\text{s}$
Propagation H to L	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 75\text{ }\Omega$ , 50 % of $V_{PP}$	$t_{PHL}$		1.1		$\mu\text{s}$
Propagation L to H	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 75\text{ }\Omega$ , 50 % of $V_{PP}$	$t_{PLH}$		2.5		$\mu\text{s}$
<b>SATURATED</b>						
On time	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 1\text{ k}\Omega$ , $V_{TH} = 1.5\text{ V}$ ,	$t_{on}$		4.3		$\mu\text{s}$
Rise time	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 1\text{ k}\Omega$ , $V_{TH} = 1.5\text{ V}$ ,	$t_r$		2.8		$\mu\text{s}$
Off time	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 1\text{ k}\Omega$ , $V_{TH} = 1.5\text{ V}$ ,	$t_{off}$		2.5		$\mu\text{s}$
Fall time	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 1\text{ k}\Omega$ , $V_{TH} = 1.5\text{ V}$ ,	$t_f$		11		$\mu\text{s}$
Propagation H to L	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 1\text{ k}\Omega$ , $V_{TH} = 1.5\text{ V}$ ,	$t_{PHL}$		2.6		$\mu\text{s}$
Propagation L to H	$I_F = \pm 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 1\text{ k}\Omega$ , $V_{TH} = 1.5\text{ V}$ ,	$t_{PLH}$		7.2		$\mu\text{s}$

## TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

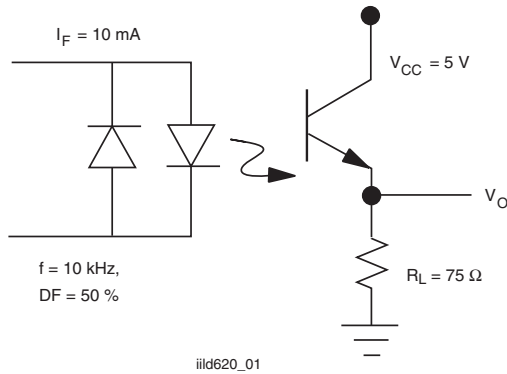


Fig. 3 - Non-Saturated Switching Timing

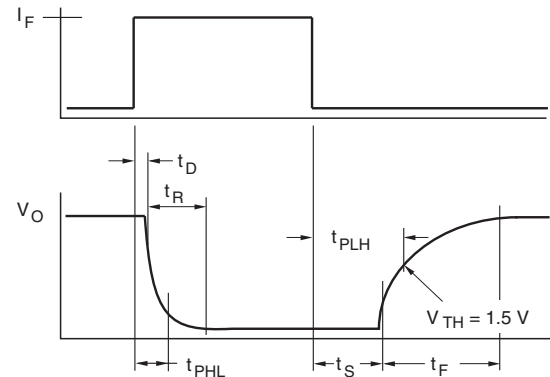


Fig. 6 - Saturated Switching Timing

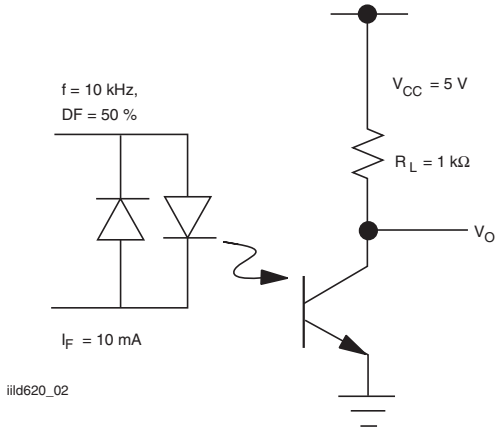


Fig. 4 - Saturated Switching Timing

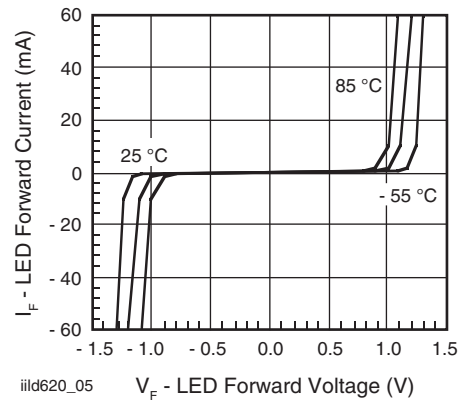


Fig. 7 - LED Forward Current vs. Forward Voltage

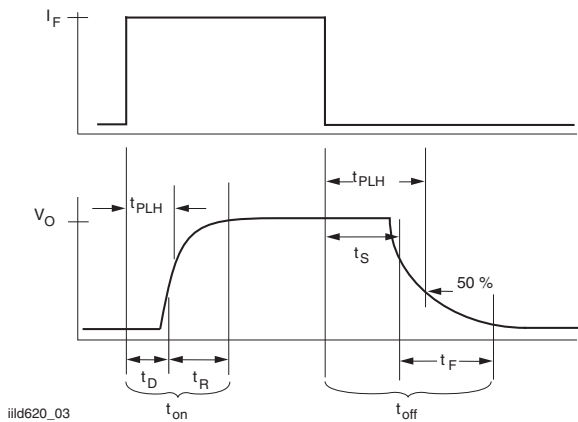


Fig. 5 - Non-Saturated Switching Timing

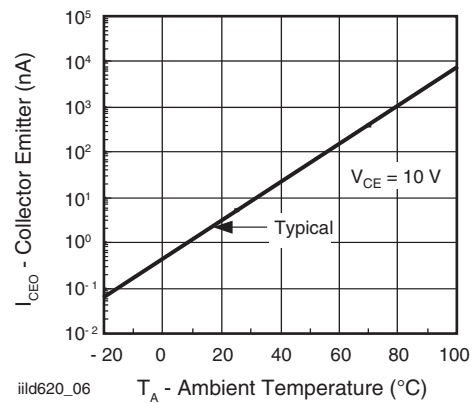


Fig. 8 - Collector Emitter Leakage vs. Temperature

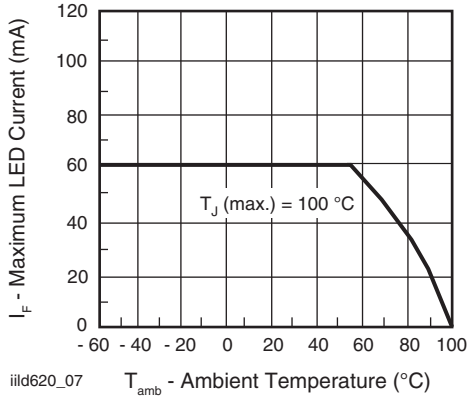


Fig. 9 - Maximum LED Current vs. Ambient Temperature

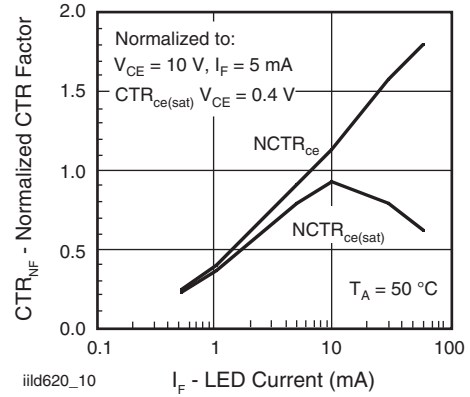


Fig. 12 - Normalization Factor for Non-Saturated and Saturated CTR vs.  $I_F$

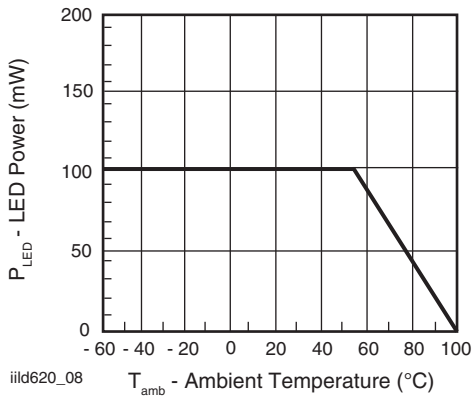


Fig. 10 - Maximum LED Power Dissipation

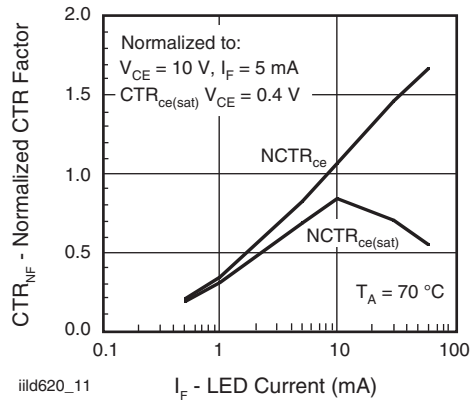


Fig. 13 - Normalization Factor for Non-Saturated and Saturated CTR vs.  $I_F$

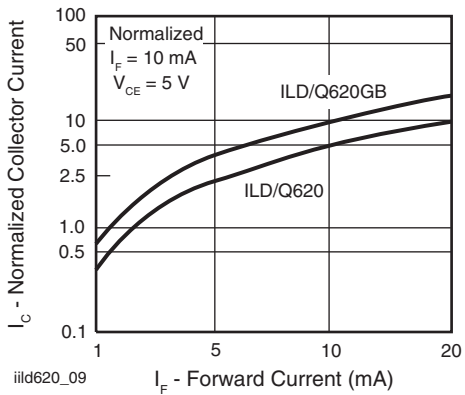


Fig. 11 - Collector Current vs. Diode Forward Current

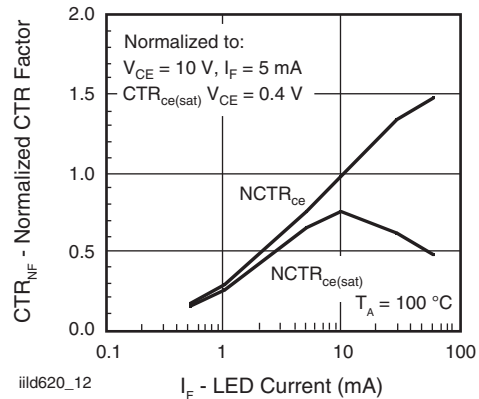


Fig. 14 - Normalization Factor for Non-Saturated and Saturated CTR vs.  $I_F$

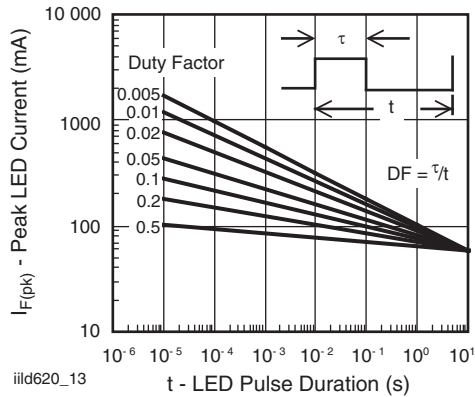


Fig. 15 - Peak LED Current vs. Pulse Duration,  $\tau$

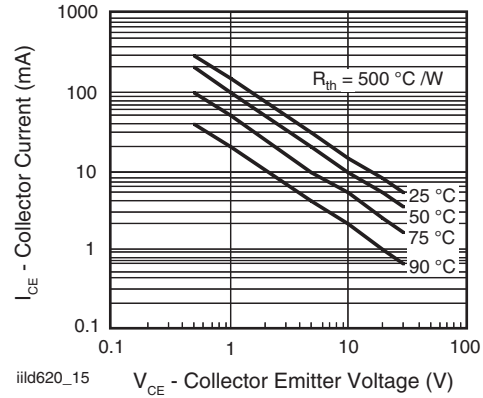


Fig. 17 - Maximum Collector Current vs. Collector Voltage

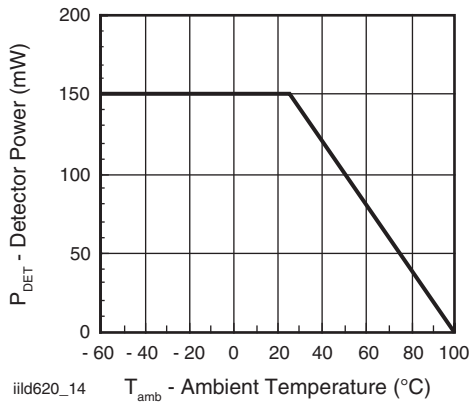
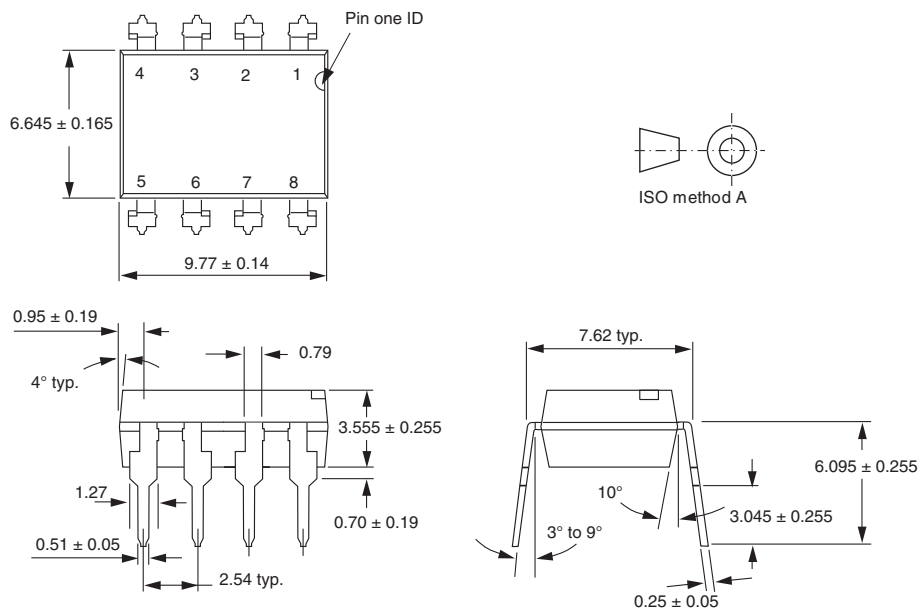
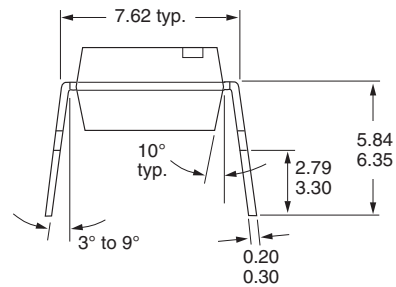
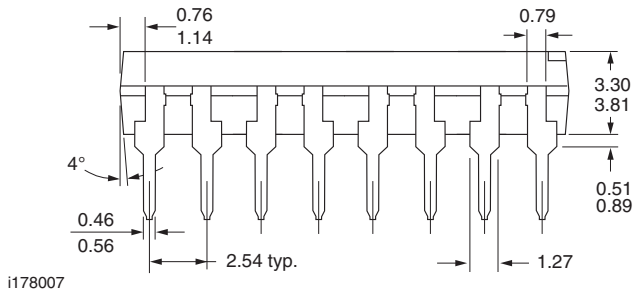
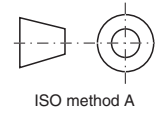
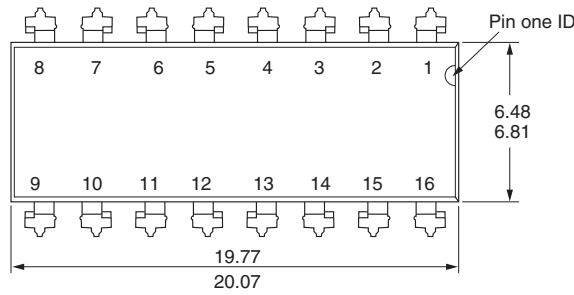


Fig. 16 - Maximum Detector Power Dissipation

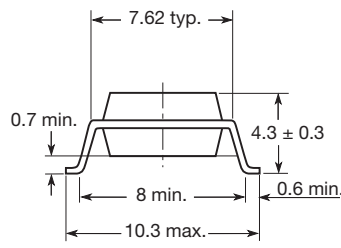
**PACKAGE DIMENSIONS** in millimeters



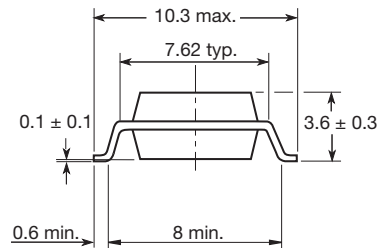


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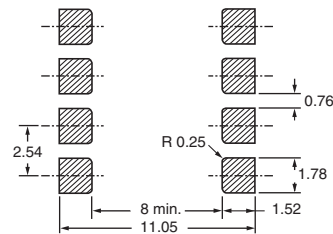
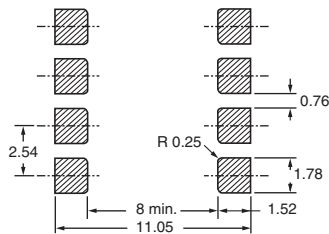
**Option 7**



**Option 9**



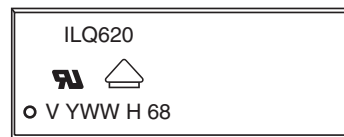
20802-16



**PACKAGE MARKING (example)**



21764-95



**Notes**

- Only option 1 and 7 reflected in the package marking.
- The VDE logo is only marked on option 1 parts.
- Tape and reel suffix (T) is not part of the package marking.



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**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**

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